2-27-62

27

FLH Ref. No.: 450101-03635

U.S. DEPARTMENT OF COMMERCE

102012	283 Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademarks: Pl	ease record the attached original documents or copy thereof.
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)
Natsuko YOTSUMOTO, Masahiro ASAI, Mami UCHIDA, Takaaki MIURA, Katsuhisa TAKATA	Name: SONY CORPORATION 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 141-0001, Japan
Additional name(s) of conveying party(ies) attached? Yes _XNo	and JUSTSYSTEM CORPORATION 108-4, Wakamatsu Hiraishi Kawauchi-cho Tokushima-shi Tokushima, Japan
3. Nature of conveyance:	Tokusitina, vapati
X Assignment Security Agreement Merger Change of Name Other	Additional name(s) & address(es) attached? Yes _x No
Execution Date(s): <u>January 31, January 31, January 31,</u> <u>January 21 and January 21, 2001</u>	OFFICE (TEP)
4. Application number(s) or patent number(s):	
If this document is being filed together with the application is:	h a new application, the execution date of
A. Patent Application No.(s) 09/996,519 filed Novembe	r 29, 2001
Additional numbers atta	ached? Yes _X _ No
 Name and address of party to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved
Name: WILLIAM S. FROMMER	7. Total fee (37 CFR 3.41)
Internal Address: FROMMER LAWRENCE & HAUG LLP	X Enclosed Authorized to be charged to deposit account 50-0320
Street Address: 745 FIFTH AVENUE	9 Denosit account number:
City: <u>NEW YORK</u> State: <u>N.Y.</u> Zip: <u>10151</u>	(Attach duplicate copy of this page if paying by deposit account)
Do not use	e this space
9. Statement and signature. To the best of my knowledge and belief, the foregoing info copy of the original document. 7. The foregoing info copy of the original document.	ormation is true and correct and any attached copy is a true
SUSANIE SAVIT	February 13, 2002
GLENN F. SAVIT Name of Person Signing Sign	Total number of pages including cover sheet, attachments, and document: 3
1/2002 LMMELLER 00000128 09996519	
	ch this portion required cover sheet information to:
Commissioner of P	atents and Trademarks ssignments
Washingto	n, D.C. 20231
Public burden reporting for this sample cover sheet is estimate including time for reviewing the document and gathering the County Send comments regarding this burden estimate to the U.S. Pate PK2-1000C, Washington, D.C. 20231, and to the Office of Manage Washington, D.C. 20503.	ated to average about 30 minutes per document to be recorded, and completing and reviewing the sample cover sheet. The sample cover sheet and Trademark Office, Office of Information Systems, gement and Budget, Paperwork Reduction Project (0651-0011),
Washington	

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and

INFORMATION PROCESSING METHOD AND APPARATUS AND RECORDING MEDIUM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141, Japan and JUSISYSIEM CORPORATION, a Japanese corporation, with offices at 108-4, Wakamatsu Hiraishi Kawauchi-cho Tokushima-shi Tokushima, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable NOW INEXEFURE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, and apply other international agreements to which the United States of America address and Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto:

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/996.519, Filing Date: November 29, 2001.

This assignment executed on the dates indicated below.

Natsuko YOTSUMOTO	
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo. Japan	
Residence of first or sole inventor Mutsuse Yestsugneti Signature of first or sole inventor	Date of this assignment
Masahiro ASAI Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor Marchita Cital Signature of second inventor	Date of this assignment
Mami UCHIDA	Execution date of U.S. Patent Application
Name of third inventor Saitama, Japan	
Residence of third inventor Amana (Chical Signature of third inventor	Date of this assignment

ADDITIONAL INVENTORS

Takaaki MIURA	
Name of fourth inventor	Execution date of U.S. Patent Application
Tokushima, Japan	
Residence of fourth inventor Takaaki Miura	1/21/2002
Signature of fourth inventor	Date of this assignment
Katsuhisa TAKATA	
Name of fifth inventor	Execution date of U.S. Patent Application
Tokushima, Japan	
Residence of fifth inventor Katsuhisa Takata	1/21/2002
Signature of fifth inventor	Date of this assignment

Page 2 of 2

RECORDED: 02/27/2002

PATENT REEL: 012647 FRAME: 0890